

50A, 1000V Hyperfast Diode

The RHRG50100 is a hyperfast diode with soft recovery characteristics ($t_{rr} < 75\text{ns}$). It has half the recovery time of ultrafast diodes and is of silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as a freewheeling/clamping diode and rectifier in a variety of switching power supplies and other power switching applications. Its low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits, thus reducing power loss in the switching transistors.

Formerly developmental type TA49066.

Ordering Information

PART NUMBER	PACKAGE	BRAND
RHRG50100	TO-247	RHRG50100

NOTE: When ordering, use the entire part number.

Symbol



Absolute Maximum Ratings $T_C = 25^\circ\text{C}$

	RHRG50100	UNITS
Peak Repetitive Reverse Voltage	V_{RRM}	V
Working Peak Reverse Voltage	V_{RWM}	V
DC Blocking Voltage	V_R	V
Average Rectified Forward Current ($T_C = 60^\circ\text{C}$)	$I_{F(AV)}$	A
Repetitive Peak Surge Current (Square Wave, 20kHz)	I_{FRM}	A
Nonrepetitive Peak Surge Current (Halfwave, 1 Phase, 60Hz)	I_{FSM}	A
Maximum Power Dissipation	P_D	W
Avalanche Energy (See Figures 7 and 8)	E_{AVL}	mJ
Operating and Storage Temperature	T_{STG}, T_J	$^\circ\text{C}$

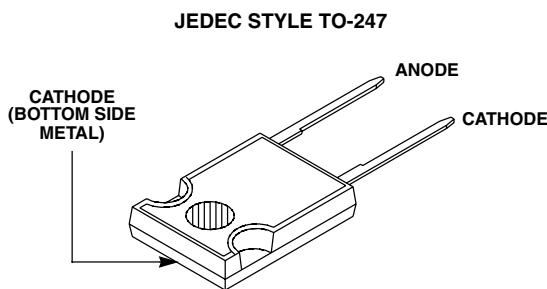
Features

- Hyperfast with Soft Recovery <75ns
- Operating Temperature 175°C
- Reverse Voltage 1000V
- Avalanche Energy Rated
- Planar Construction

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

Packaging



Electrical Specifications $T_C = 25^\circ\text{C}$, Unless Otherwise Specified

SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
V_F	$I_F = 50\text{A}$	-	-	3.0	V
	$I_F = 50\text{A}, T_C = 150^\circ\text{C}$	-	-	2.5	V
I_R	$V_R = 1000\text{V}$	-	-	250	μA
	$V_R = 1000\text{V}, T_C = 150^\circ\text{C}$	-	-	3.0	mA
t_{rr}	$I_F = 1\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$	-	-	75	ns
	$I_F = 50\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$	-	-	95	ns
t_a	$I_F = 50\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$	-	54	-	ns
t_b	$I_F = 50\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$	-	32	-	ns
$R_{\theta\text{JC}}$		-	-	1.0	$^\circ\text{C}/\text{W}$

DEFINITIONS

V_F = Instantaneous forward voltage (pw = 300 μs , D = 2%).

I_R = Instantaneous reverse current.

t_{rr} = Reverse recovery time (See Figure 6), summation of $t_a + t_b$.

t_a = Time to reach peak reverse current (See Figure 6).

t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 6).

$R_{\theta\text{JC}}$ = Thermal resistance junction to case.

pw = Pulse width.

D = Duty cycle.

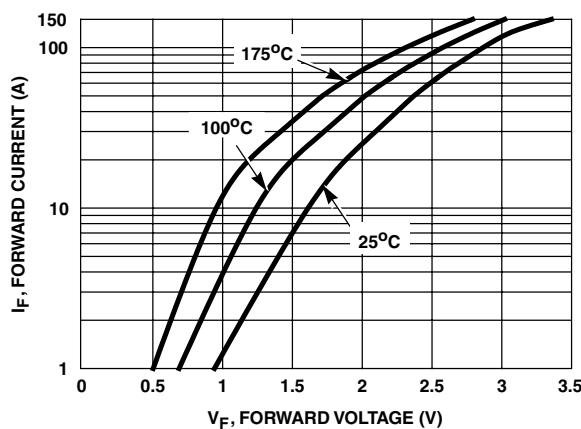
Typical Performance Curves

FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

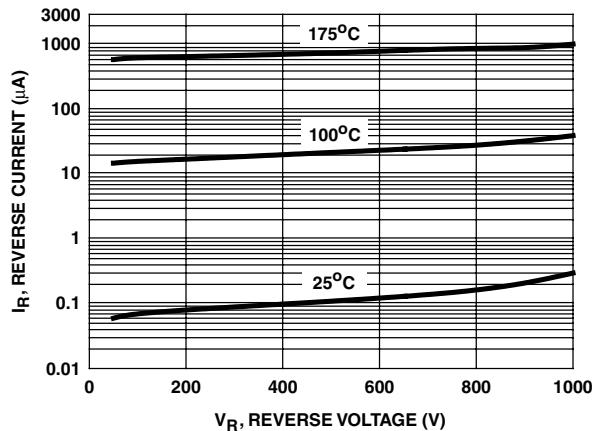


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

Typical Performance Curves (Continued)

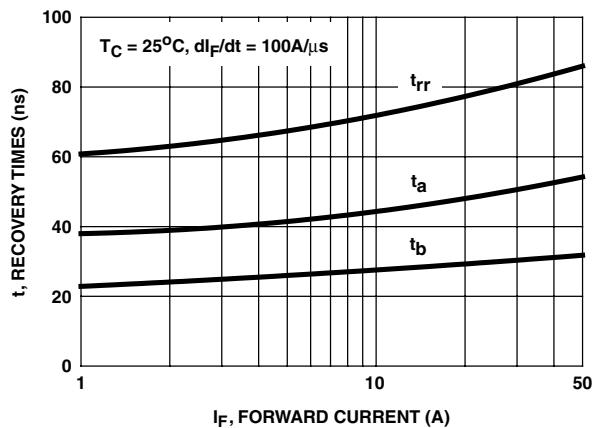


FIGURE 3. t_{rr} , t_a AND t_b CURVES vs FORWARD CURRENT

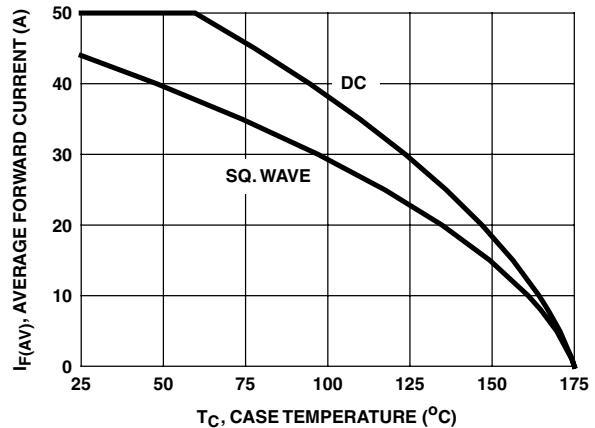


FIGURE 4. CURRENT DERATING CURVE

Test Circuits and Waveforms

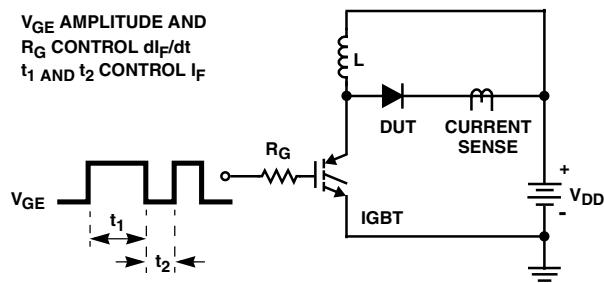


FIGURE 5. t_{rr} TEST CIRCUIT

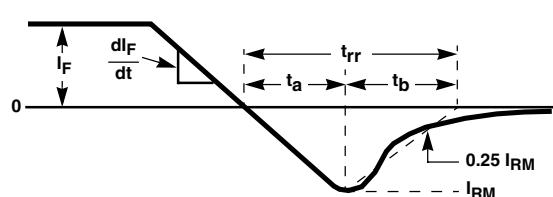


FIGURE 6. t_{rr} WAVEFORMS AND DEFINITIONS

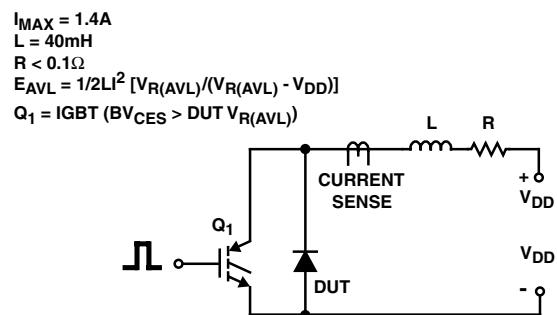


FIGURE 7. AVALANCHE ENERGY TEST CIRCUIT

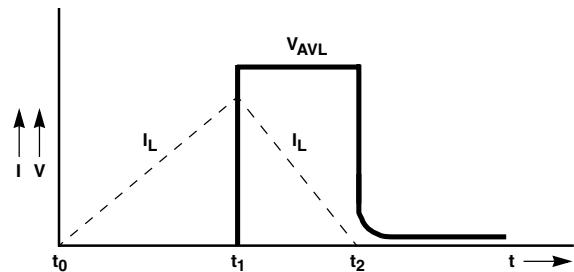


FIGURE 8. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

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